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Fairchild Semiconductor FQPF2N70

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FAIRCHILD

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FQPF2N70

N-Channel QFET[®] MOSFET **700 V, 2.0 A, 6.3** Ω

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

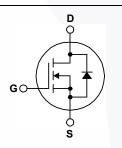
2.0 A, 700 V, $R_{DS(on)}$ = 6.3 Ω (Max.) @ V_{GS} = 10 V, I_D = 1.0 A

FQPF2N70 — N-Channel QFET[®] MOSFET

November 2013

- Low Gate Charge (Typ. 9 nC)
- Low Crss (Typ. 5 pF)
- · 100% Avalanche Tested





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		Parameter		FQPF2N70	Unit
V _{DSS}	Drain-Source Voltage			700	V
I _D	Drain Current	- Continuous (T _C = 25°C)		2.0*	Α
		- Continuous (T _C = 100°C)		1.3*	Α
I _{DM}	Drain Current	- Pulsed (No	ote 1)	8.0*	Α
V _{GSS}	Gate-Source Voltage		± 30	V	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			140	mJ
I _{AR}	Avalanche Current (Note 1)		ote 1)	2.0	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		2.8	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		ote 3)	4.5	V/ns
P _D	Power Dissipation	(T _C = 25°C)		28	W
		- Derate Above 25°C		0.22	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
Τ _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds			300	°C

ion temperature

Thermal Characteristics

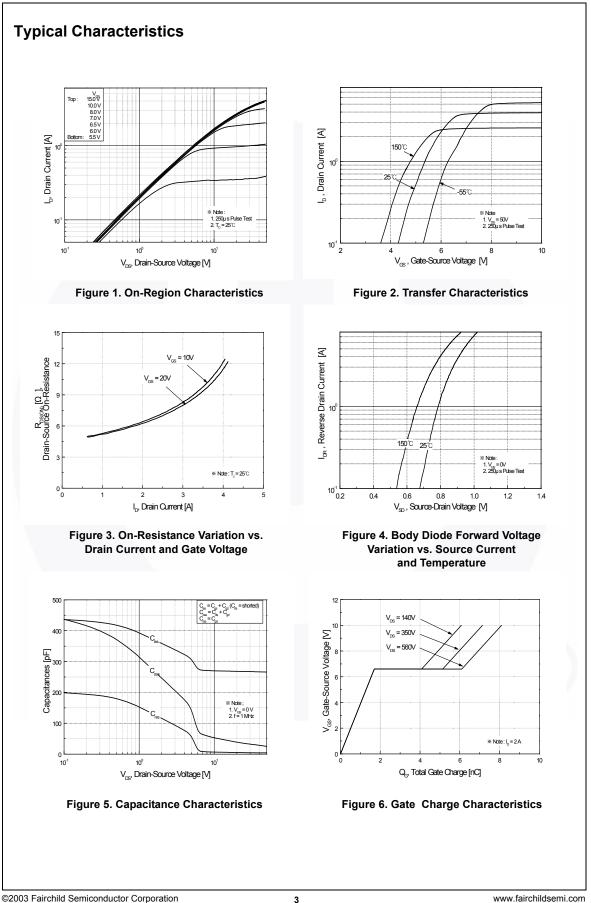
Symbol	Parameter	FQPF2N70	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	4.46	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.		C/VV	



Part Number Top Mark Package		e Packing Method Reel Size		Tape Width		Qu	Quantity		
FQPF2	QPF2N70 FQPF2N70 TO-220F		Tube N/A		N/A		50	50 units	
ectri	cal Ch	aracteristics	5 T _C = 25	°C unless otherwise n	oted.				
Symbol	Parameter			Test Condit	ions	Min. Typ. Max		Max.	Unit
		-4:							
	1	Source Breakdown V	/oltaga	V _{GS} = 0 V, I _D = 250 µ	. A	700	1		V
BV _{DSS} ∆BV _{DSS}			•	V _{GS} = 0 V; I _D = 200 μA		700			v
$\Delta D V_{DSS}$	Breakdown Voltage Temperature Coefficient		I_D = 250 μ A, Referenced to 25°C			0.4		V/°C	
I _{DSS}				V _{DS} = 700 V, V _{GS} = 0 V				10	μA
000	Zero Gate Voltage Drain Current		urrent	$V_{DS} = 560 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$				100	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward		nt, Forward	V _{GS} = 30 V, V _{DS} = 0 V				100	nA
I _{GSSR}		ody Leakage Currei		$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
On Cha	rootori	otioo							1
V _{GS(th)}	1	nreshold Voltage		V _{DS} = V _{GS} , I _D = 250	uА	3.0		5.0	V
R _{DS(on)}	Statia Drain Source				0.0				
DO(011)				V _{GS} = 10 V, I _D = 1.0 A			5.0	6.3	Ω
9 _{FS}	Forward Transconductance			V _{DS} = 50 V, I _D = 1.0 A			2.45		S
Dynam	ic Char	acteristics							
C _{iss}	Input C	apacitance		V _{DS} = 25 V, V _{GS} = 0 V,			270	350	pF
C _{oss}	Output	put Capacitance		f = 1.0 MHz			38	50	pF
C _{rss}	Reverse Transfer Capacitance					5	7	pF	
Switch	ina Cha	aracteristics							
t _{d(on)}	. .	n Delay Time						30	ns
t _r	Turn-O	n Rise Time		V_{DD} = 350 V, I _D = 2.0 A, R _G = 25 Ω				80	ns
t _{d(off)}	Turn-O	ff Delay Time						50	ns
t _f	Turn-O	ff Fall Time			(Note 4)			70	ns
Q _q	Total G	ate Charge		V _{DS} = 560 V, I _D = 2.0 A, V _{GS} = 10 V			8.1	11	nC
Q _{gs}	Gate-S	ource Charge					1.7		nC
Q _{gd}	Gate-D	rain Charge		00		4.4		nC	
Drain-S	ource	Diode Charact	eristics an	d Maximum Rati	nas				
I _S	1			de Forward Current	J -			2.0	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F						8.0	Α	
V _{SD}	Drain-Source Diode Forward Voltage		$V_{GS} = 0 V, I_S = 2.0 A$				1.4	V	
t _{rr}		e Recovery Time	J	V _{GS} = 0 V, I _S = 2.0 A,			260		ns
Q _{rr}	Reverse Recovery Charge			dI _F / dt = 100 A/μs			1.09		μC

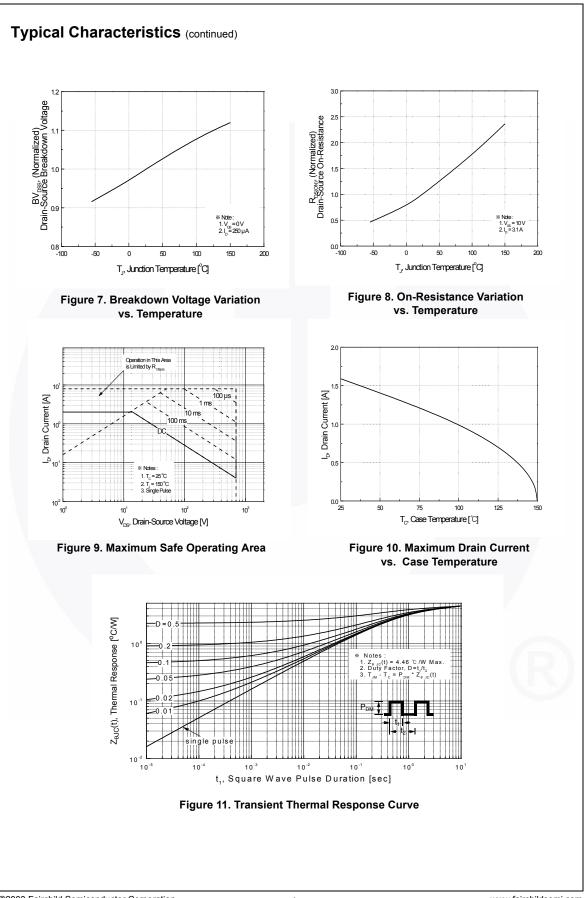
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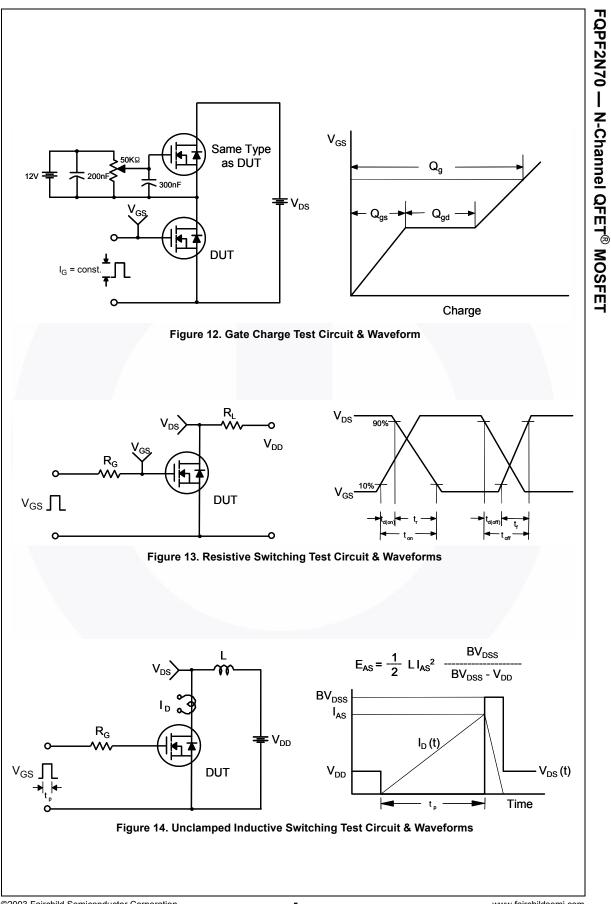




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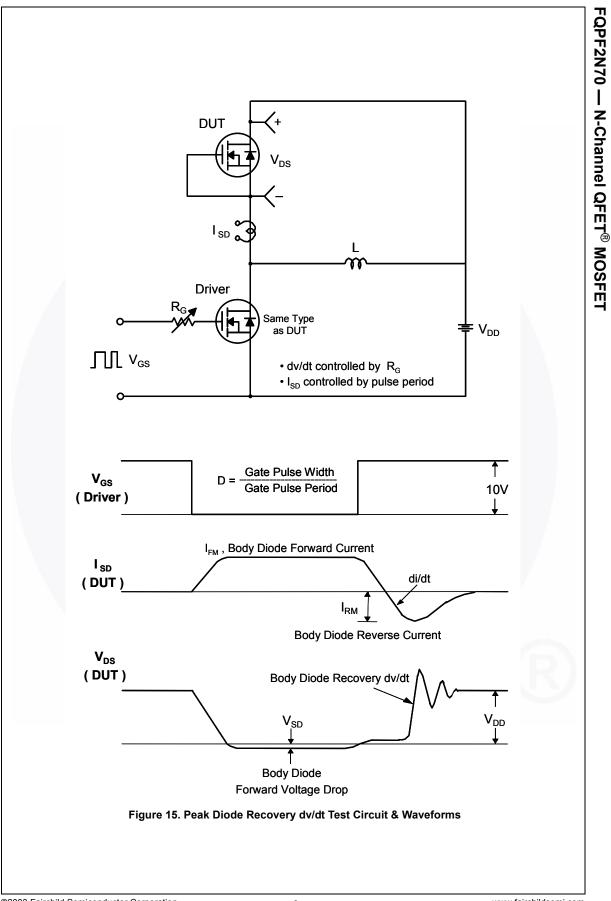
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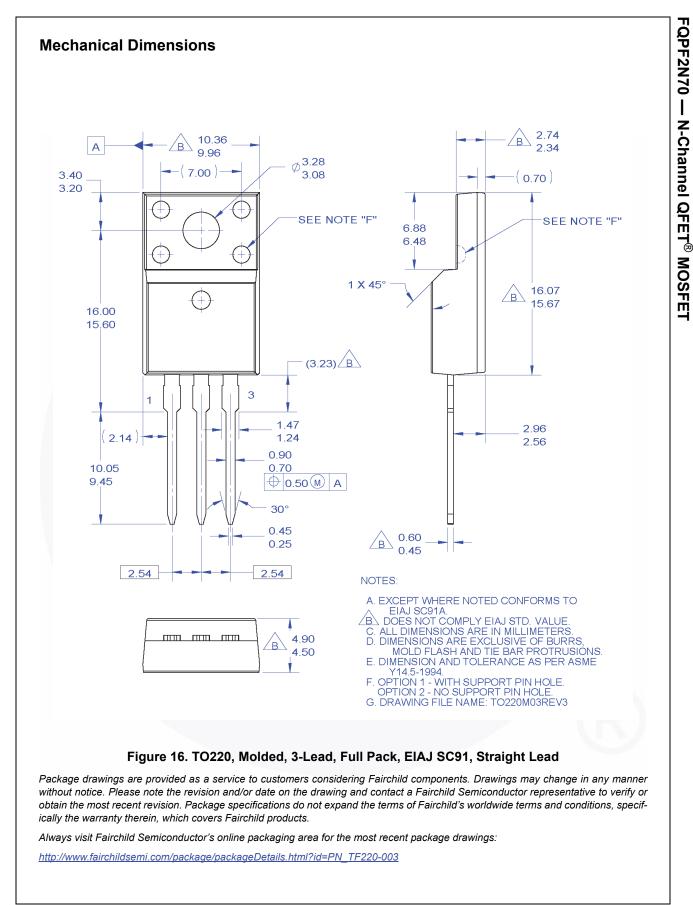


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FQPF2N70 Rev. C1

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